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Details

Product Status	Active
Core Processor	ARM® Cortex®-M4
Core Size	32-Bit Single-Core
Speed	72MHz
Connectivity	CANbus, EBI/EMI, I ² C, IrDA, LINbus, SmartCard, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	53
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	384K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.8V
Data Converters	A/D 16x12b SAR; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-TQFP
Supplier Device Package	64-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/efm32gg11b110f2048gq64-br

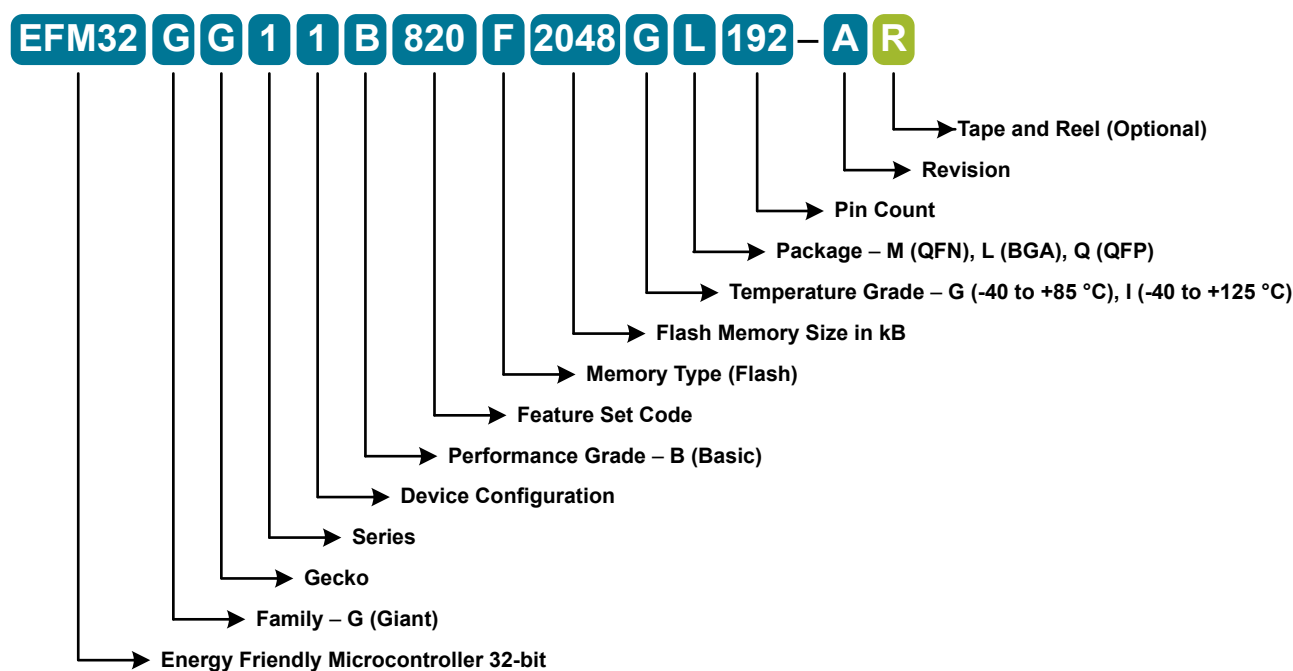


Figure 2.1. Ordering Code Key

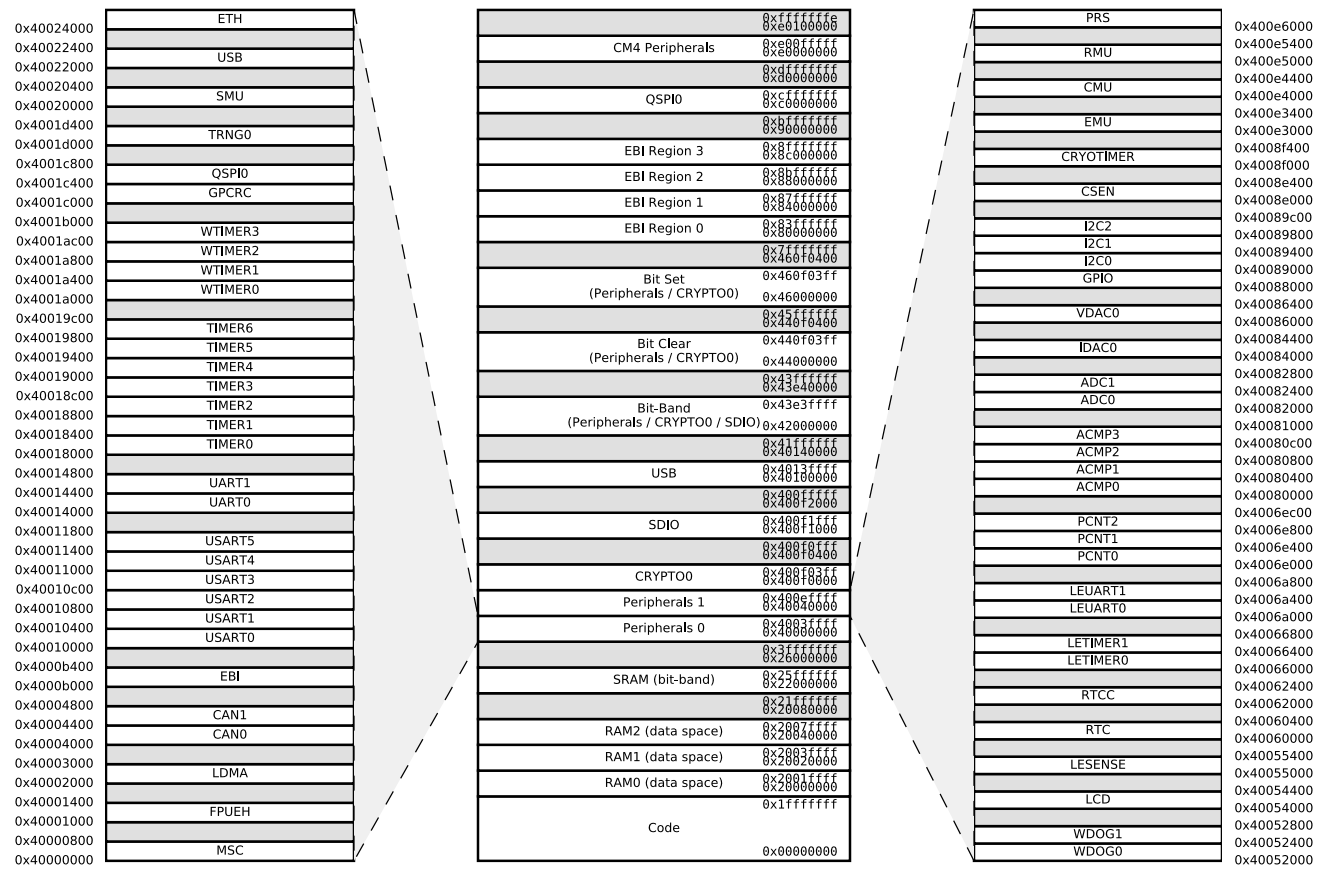


Figure 3.3. EFM32GG11 Memory Map — Peripherals

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Current consumption in EM0 mode with all peripherals disabled, DCDC in LP mode ³	I _{ACTIVE_LPM}	32 MHz HFRCO, CPU running while loop from flash	—	82	—	μA/MHz
		26 MHz HFRCO, CPU running while loop from flash	—	83	—	μA/MHz
		16 MHz HFRCO, CPU running while loop from flash	—	88	—	μA/MHz
		1 MHz HFRCO, CPU running while loop from flash	—	257	—	μA/MHz
Current consumption in EM0 mode with all peripherals disabled and voltage scaling enabled, DCDC in Low Noise CCM mode ¹	I _{ACTIVE_CCM_VS}	19 MHz HFRCO, CPU running while loop from flash	—	117	—	μA/MHz
		1 MHz HFRCO, CPU running while loop from flash	—	1231	—	μA/MHz
Current consumption in EM0 mode with all peripherals disabled and voltage scaling enabled, DCDC in LP mode ³	I _{ACTIVE_LPM_VS}	19 MHz HFRCO, CPU running while loop from flash	—	72	—	μA/MHz
		1 MHz HFRCO, CPU running while loop from flash	—	219	—	μA/MHz
Current consumption in EM1 mode with all peripherals disabled, DCDC in Low Noise DCM mode ²	I _{EM1_DCM}	72 MHz HFRCO	—	42	—	μA/MHz
		50 MHz crystal	—	46	—	μA/MHz
		48 MHz HFRCO	—	46	—	μA/MHz
		32 MHz HFRCO	—	53	—	μA/MHz
		26 MHz HFRCO	—	57	—	μA/MHz
		16 MHz HFRCO	—	72	—	μA/MHz
		1 MHz HFRCO	—	663	—	μA/MHz
Current consumption in EM1 mode with all peripherals disabled, DCDC in Low Power mode ³	I _{EM1_LPM}	32 MHz HFRCO	—	42	—	μA/MHz
		26 MHz HFRCO	—	43	—	μA/MHz
		16 MHz HFRCO	—	48	—	μA/MHz
		1 MHz HFRCO	—	219	—	μA/MHz
Current consumption in EM1 mode with all peripherals disabled and voltage scaling enabled, DCDC in Low Noise DCM mode ²	I _{EM1_DCM_VS}	19 MHz HFRCO	—	60	—	μA/MHz
		1 MHz HFRCO	—	637	—	μA/MHz
Current consumption in EM1 mode with all peripherals disabled and voltage scaling enabled. DCDC in LP mode ³	I _{EM1_LPM_VS}	19 MHz HFRCO	—	39	—	μA/MHz
		1 MHz HFRCO	—	190	—	μA/MHz
Current consumption in EM2 mode, with voltage scaling enabled, DCDC in LP mode ³	I _{EM2_VS}	Full 512 kB RAM retention and RTCC running from LFXO	—	2.8	—	μA
		Full 512 kB RAM retention and RTCC running from LFRCO	—	3.1	—	μA
		16 kB (1 bank) RAM retention and RTCC running from LFRCO ⁵	—	2.1	—	μA
Current consumption in EM3 mode, with voltage scaling enabled	I _{EM3_VS}	Full 512 kB RAM retention and CRYOTIMER running from ULFR-CO	—	2.4	—	μA

4.1.8 Wake Up Times

Table 4.10. Wake Up Times

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Wake up time from EM1	t_{EM1_WU}		—	3	—	AHB Clocks
Wake up from EM2	t_{EM2_WU}	Code execution from flash	—	11.8	—	μs
		Code execution from RAM	—	4.1	—	μs
Wake up from EM3	t_{EM3_WU}	Code execution from flash	—	11.8	—	μs
		Code execution from RAM	—	4.1	—	μs
Wake up from EM4H ¹	t_{EM4H_WU}	Executing from flash	—	94	—	μs
Wake up from EM4S ¹	t_{EM4S_WU}	Executing from flash	—	294	—	μs
Time from release of reset source to first instruction execution	t_{RESET}	Soft Pin Reset released	—	55	—	μs
		Any other reset released	—	359	—	μs
Power mode scaling time	t_{SCALE}	VSCALE0 to VSCALE2, HFCLK = 19 MHz ^{4 2}	—	31.8	—	μs
		VSCALE2 to VSCALE0, HFCLK = 19 MHz ³	—	4.3	—	μs

Note:

1. Time from wake up request until first instruction is executed. Wakeup results in device reset.
2. VSCALE0 to VSCALE2 voltage change transitions occur at a rate of 10 mV/ μs for approximately 20 μs . During this transition, peak currents will be dependent on the value of the DECOUPLE output capacitor, from 35 mA (with a 1 μF capacitor) to 70 mA (with a 2.7 μF capacitor).
3. Scaling down from VSCALE2 to VSCALE0 requires approximately 2.8 μs + 29 HFCLKs.
4. Scaling up from VSCALE0 to VSCALE2 requires approximately 30.3 μs + 28 HFCLKs.

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Hysteresis ($V_{CM} = 1.25\text{ V}$, $BIASPROG^4 = 0x10$, $FULLBIAS^4 = 1$)	$V_{ACMPHYST}$	$HYSTSEL^5 = HYST0$	TBD	0	TBD	mV
		$HYSTSEL^5 = HYST1$	TBD	18	TBD	mV
		$HYSTSEL^5 = HYST2$	TBD	33	TBD	mV
		$HYSTSEL^5 = HYST3$	TBD	46	TBD	mV
		$HYSTSEL^5 = HYST4$	TBD	57	TBD	mV
		$HYSTSEL^5 = HYST5$	TBD	68	TBD	mV
		$HYSTSEL^5 = HYST6$	TBD	79	TBD	mV
		$HYSTSEL^5 = HYST7$	TBD	90	TBD	mV
		$HYSTSEL^5 = HYST8$	TBD	0	TBD	mV
		$HYSTSEL^5 = HYST9$	TBD	-18	TBD	mV
		$HYSTSEL^5 = HYST10$	TBD	-33	TBD	mV
		$HYSTSEL^5 = HYST11$	TBD	-45	TBD	mV
		$HYSTSEL^5 = HYST12$	TBD	-57	TBD	mV
		$HYSTSEL^5 = HYST13$	TBD	-67	TBD	mV
		$HYSTSEL^5 = HYST14$	TBD	-78	TBD	mV
		$HYSTSEL^5 = HYST15$	TBD	-88	TBD	mV
Comparator delay ³	$t_{ACMPDELAY}$	$BIASPROG^4 = 1$, $FULLBIAS^4 = 0$	—	30	—	μs
		$BIASPROG^4 = 0x10$, $FULLBIAS^4 = 0$	—	3.7	—	μs
		$BIASPROG^4 = 0x02$, $FULLBIAS^4 = 1$	—	360	—	ns
		$BIASPROG^4 = 0x20$, $FULLBIAS^4 = 1$	—	35	—	ns
Offset voltage	$V_{ACMPOFFSET}$	$BIASPROG^4 = 0x10$, $FULLBIAS^4 = 1$	TBD	—	TBD	mV
Reference voltage	$V_{ACMPREF}$	Internal 1.25 V reference	TBD	1.25	TBD	V
		Internal 2.5 V reference	TBD	2.5	TBD	V
Capacitive sense internal resistance	R_{CSRES}	$CSRESSEL^6 = 0$	—	infinite	—	k Ω
		$CSRESSEL^6 = 1$	—	15	—	k Ω
		$CSRESSEL^6 = 2$	—	27	—	k Ω
		$CSRESSEL^6 = 3$	—	39	—	k Ω
		$CSRESSEL^6 = 4$	—	51	—	k Ω
		$CSRESSEL^6 = 5$	—	100	—	k Ω
		$CSRESSEL^6 = 6$	—	162	—	k Ω
		$CSRESSEL^6 = 7$	—	235	—	k Ω

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Supply current, continuous conversions, WARMUP-MODE=KEEPCSENWARM	I _{CSEN_ACTIVE}	SAR or Delta Modulation conversions of 33 pF capacitor, CS0CG=0 (Gain = 10x), always on	—	90.5	—	μA
HFPERCLK supply current	I _{CSEN_HFPERCLK}	Current contribution from HFPERCLK when clock to CSEN block is enabled.	—	2.25	—	μA/MHz

Note:

- Current is specified with a total external capacitance of 33 pF per channel. Average current is dependent on how long the module is actively sampling channels within the scan period, and scales with the number of samples acquired. Supply current for a specific application can be estimated by multiplying the current per sample by the total number of samples per period ($\text{total_current} = \text{single_sample_current} * (\text{number_of_channels} * \text{accumulation})$).

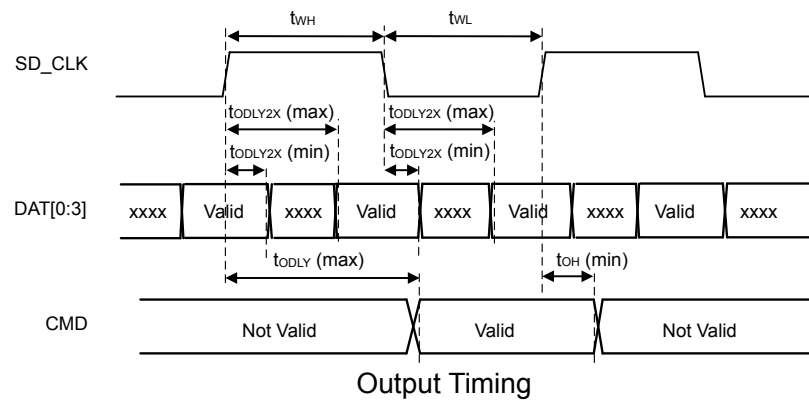
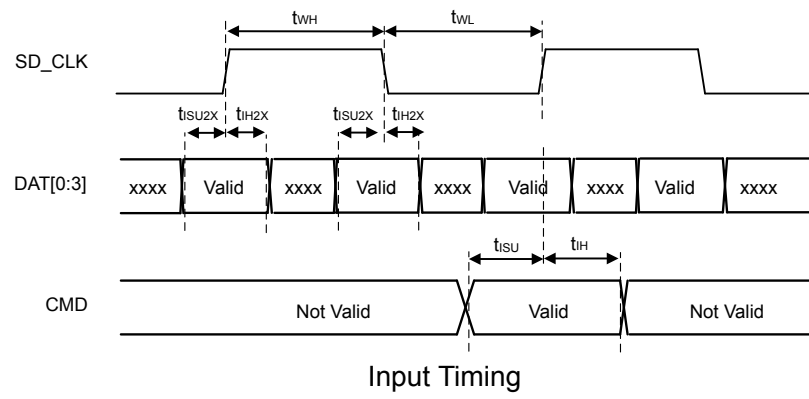


Figure 4.16. SDIO DDR Mode Timing

SDIO MMC SDR Mode Timing at 3.0 V

Timing is specified for route location 0 at 3.0 V IOVDD with voltage scaling disabled. Slew rate for SD_CLK set to 7, all other GPIO set to 6, DRIVESTRENGTH = STRONG for all pins. SDIO_CTRL_TXDLYMUXSEL = 1. Loading between 5 and 10 pF on all pins or between 10 and 20 pF on all pins.

Table 4.51. SDIO MMC SDR Mode Timing (Location 0, 3V I/O)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Clock frequency during data transfer	F_{SD_CLK}	Using HFRCO, AUXHFRCO, or USHFRCO	—	—	48	MHz
		Using HFXO	—	—	TBD	MHz
Clock low time	t_{WL}	Using HFRCO, AUXHFRCO, or USHFRCO	9.4	—	—	ns
		Using HFXO	TBD	—	—	ns
Clock high time	t_{WH}	Using HFRCO, AUXHFRCO, or USHFRCO	9.4	—	—	ns
		Using HFXO	TBD	—	—	ns
Clock rise time	t_R		1.96	3.87	—	ns
Clock fall time	t_F		1.67	3.31	—	ns
Input setup time, CMD, DAT[0:7] valid to SD_CLK	t_{ISU}		5.3	—	—	ns
Input hold time, SD_CLK to CMD, DAT[0:7] change	t_{IH}		2.5	—	—	ns
Output delay time, SD_CLK to CMD, DAT[0:7] valid	t_{ODLY}		0	—	16	ns
Output hold time, SD_CLK to CMD, DAT[0:7] change	t_{OH}		3	—	—	ns

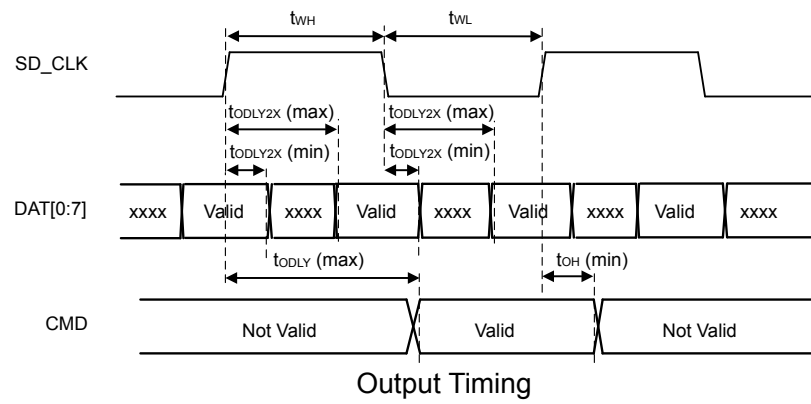
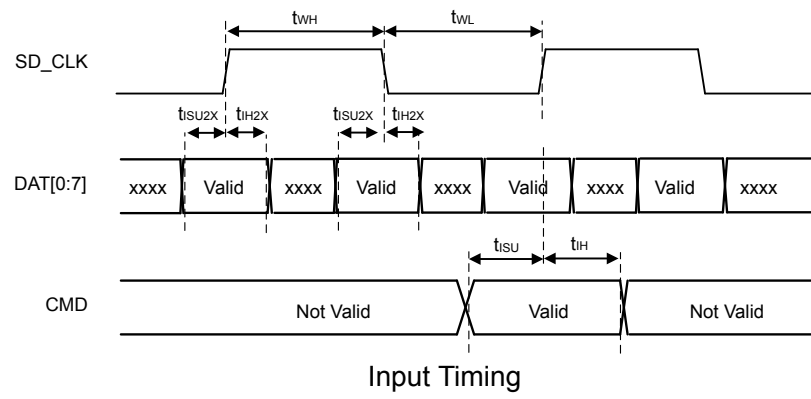


Figure 4.19. SDIO MMC DDR Mode Timing

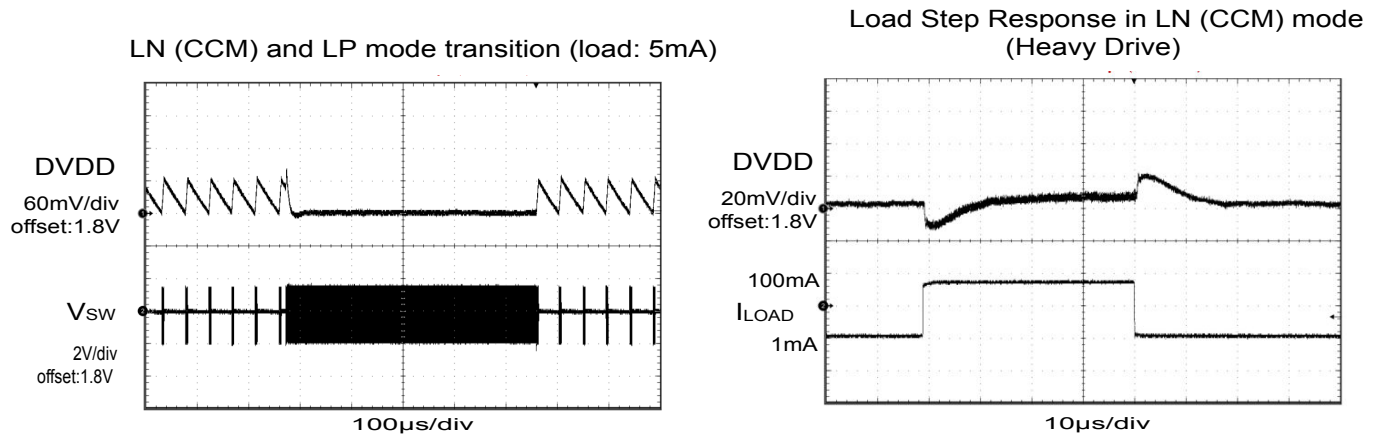


Figure 4.30. DC-DC Converter Transition Waveforms

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
VREGVDD	J13	Voltage regulator VDD input	PC0	K1	GPIO (5V)
PC1	K2	GPIO (5V)	PE0	K12	GPIO (5V)
VREGSW	K13	DCDC regulator switching node	PC2	L1	GPIO (5V)
PC3	L2	GPIO (5V)	PA7	L3	GPIO
PB9	L13	GPIO (5V)	PB10	L14	GPIO (5V)
PD1	L17	GPIO	PC6	L18	GPIO
PC7	L19	GPIO	VREGVSS	L20	Voltage regulator VSS
PB7	M1	GPIO	PC4	M2	GPIO
PA8	M3	GPIO	PA10	M4	GPIO
PA13	M5	GPIO (5V)	PA14	M6	GPIO
RESETn	M7	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.	PB12	M8	GPIO
PD0	M9	GPIO (5V)	PD2	M10	GPIO (5V)
PD3	M11	GPIO	PD4	M12	GPIO
PD8	M13	GPIO	PB8	N1	GPIO
PC5	N2	GPIO	PA9	N3	GPIO
PA11	N4	GPIO	PA12	N5	GPIO (5V)
PB11	N6	GPIO	BODEN	N7	Brown-Out Detector Enable. This pin may be left disconnected or tied to AVDD.
PB13	N8	GPIO	PB14	N9	GPIO
AVDD	N10	Analog power supply.	PD5	N11	GPIO
PD6	N12	GPIO	PD7	N13	GPIO

Note:

1. GPIO with 5V tolerance are indicated by (5V).
2. The pins PD13, PD14, and PD15 will not be 5V tolerant on all future devices. In order to preserve upgrade options with full hardware compatibility, do not use these pins with 5V domains.

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PB2	11	GPIO	PB3	12	GPIO
PB4	13	GPIO	PB5	14	GPIO
PB6	15	GPIO	VSS	16 32 58 83	Ground
PC0	18	GPIO (5V)	PC1	19	GPIO (5V)
PC2	20	GPIO (5V)	PC3	21	GPIO (5V)
PC4	22	GPIO	PC5	23	GPIO
PB7	24	GPIO	PB8	25	GPIO
PA7	26	GPIO	PA8	27	GPIO
PA9	28	GPIO	PA10	29	GPIO
PA11	30	GPIO	PA12	33	GPIO (5V)
PA13	34	GPIO (5V)	PA14	35	GPIO
RESETn	36	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.	PB9	37	GPIO (5V)
PB10	38	GPIO (5V)	PB11	39	GPIO
PB12	40	GPIO	AVDD	41 45	Analog power supply.
PB13	42	GPIO	PB14	43	GPIO
PD0	46	GPIO (5V)	PD1	47	GPIO
PD2	48	GPIO (5V)	PD3	49	GPIO
PD4	50	GPIO	PD5	51	GPIO
PD6	52	GPIO	PD7	53	GPIO
PD8	54	GPIO	PC6	55	GPIO
PC7	56	GPIO	DVDD	57	Digital power supply.
DECOUPLE	59	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.	PE0	60	GPIO (5V)
PE1	61	GPIO (5V)	PE2	62	GPIO
PE3	63	GPIO	PE4	64	GPIO
PE5	65	GPIO	PE6	66	GPIO
PE7	67	GPIO	PC8	68	GPIO (5V)
PC9	69	GPIO (5V)	PC10	70	GPIO (5V)
PC11	71	GPIO (5V)	PC12	72	GPIO (5V)
PC13	73	GPIO (5V)	PC14	74	GPIO (5V)
PC15	75	GPIO (5V)	PF0	76	GPIO (5V)
PF1	77	GPIO (5V)	PF2	78	GPIO

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PC4	13	GPIO	PC5	14	GPIO
PB7	15	GPIO	PB8	16	GPIO
PA8	17	GPIO	PA12	18	GPIO (5V)
PA14	19	GPIO	RESETn	20	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.
PB11	21	GPIO	PB12	22	GPIO
AVDD	24	Analog power supply.	PB13	25	GPIO
PB14	26	GPIO	PD0	28	GPIO (5V)
PD1	29	GPIO	PD2	30	GPIO (5V)
PD3	31	GPIO	PD4	32	GPIO
PD5	33	GPIO	PD6	34	GPIO
PD7	35	GPIO	PD8	36	GPIO
PC7	37	GPIO	VREGVSS	38	Voltage regulator VSS
VREGSW	39	DCDC regulator switching node	VREGVDD	40	Voltage regulator VDD input
DVDD	41	Digital power supply.	DECOUPLE	42	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.
PE4	43	GPIO	PE5	44	GPIO
PE6	45	GPIO	PE7	46	GPIO
PC12	47	GPIO (5V)	PC13	48	GPIO (5V)
PF0	49	GPIO (5V)	PF1	50	GPIO (5V)
PF2	51	GPIO	PF3	52	GPIO
PF4	53	GPIO	PF5	54	GPIO
PE8	57	GPIO	PE9	58	GPIO
PE10	59	GPIO	PE11	60	GPIO
PE12	61	GPIO	PE13	62	GPIO
PE14	63	GPIO	PE15	64	GPIO

Note:

1. GPIO with 5V tolerance are indicated by (5V).

5.19 EFM32GG11B1xx in QFN64 Device Pinout

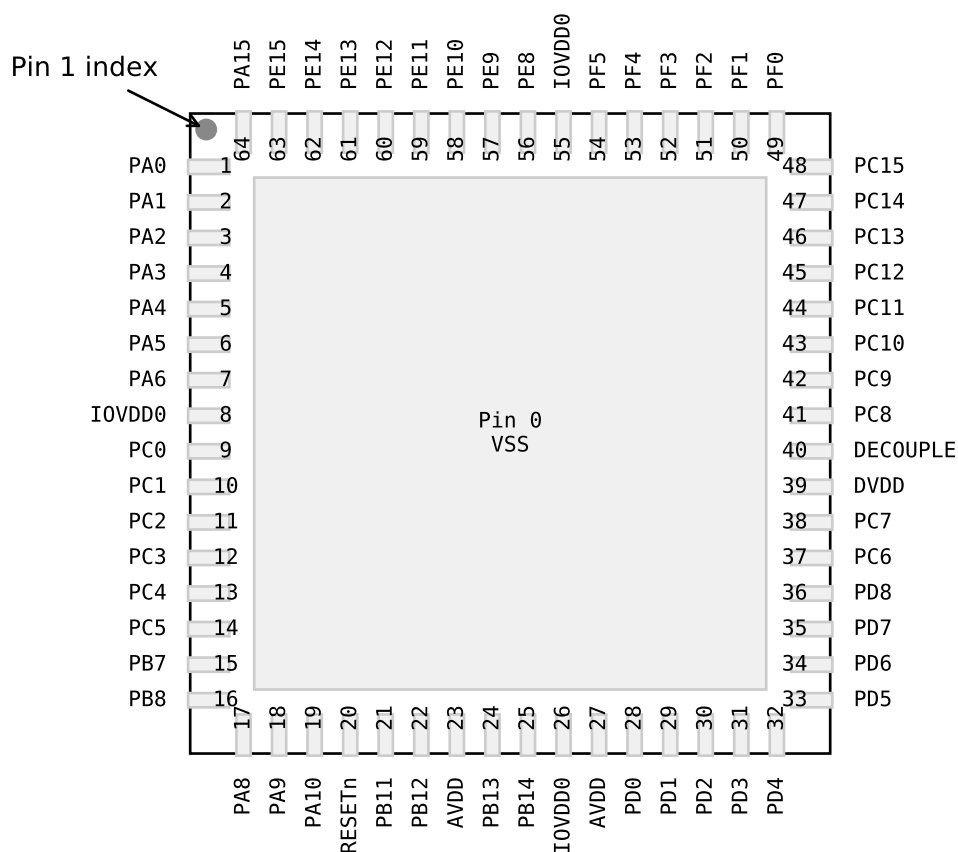


Figure 5.19. EFM32GG11B1xx in QFN64 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see [5.20 GPIO Functionality Table](#) or [5.21 Alternate Functionality Overview](#).

Table 5.19. EFM32GG11B1xx in QFN64 Device Pinout

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
VSS	0	Ground	PA0	1	GPIO
PA1	2	GPIO	PA2	3	GPIO
PA3	4	GPIO	PA4	5	GPIO
PA5	6	GPIO	PA6	7	GPIO
IOVDD0	8 26 55	Digital IO power supply 0.	PC0	9	GPIO (5V)
PC1	10	GPIO (5V)	PC2	11	GPIO (5V)

5.20 GPIO Functionality Table

A wide selection of alternate functionality is available for multiplexing to various pins. The following table shows the name of each GPIO pin, followed by the functionality available on that pin. Refer to [5.21 Alternate Functionality Overview](#) for a list of GPIO locations available for each function.

Table 5.20. GPIO Functionality Table

GPIO Name	Pin Alternate Functionality / Description				
	Analog	EBI	Timers	Communication	Other
PA15	BUSAY BUSBX LCD_SEG12	EBI_AD08 #0	TIM3_CC2 #0	ETH_MIIRXCLK #0 ETH_MDIO #3 US2_CLK #3	PRS_CH15 #0
PE15	BUSCY BUSDX LCD_SEG11	EBI_AD07 #0	TIM2_CDTI2 #2 TIM3_CC1 #0	ETH_RMIITXD0 #0 ETH_MIIRXD3 #0 SDIO_CMD #1 US0_RTS #0 QSPI0_DQS #1 LEU0_RX #2	PRS_CH14 #2 ETM_TD3 #4
PE14	BUSDY BUSCX LCD_SEG10	EBI_AD06 #0	TIM2_CDTI1 #2 TIM3_CC0 #0	ETH_RMIITXD1 #0 ETH_MIIRXD2 #0 SDIO_CLK #1 US0_CTS #0 QSPI0_SCLK #1 LEU0_TX #2	PRS_CH13 #2 ETM_TD2 #4
PE13	BUSCY BUSDX LCD_SEG9	EBI_AD05 #0	TIM1_CC3 #1 TIM2_CC2 #3 LE- TIM0_OUT1 #4	SDIO_CLK #0 ETH_MIIRXD1 #0 US0_TX #3 US0_CS #0 U1_RX #4 I2C0_SCL #6	LES_ALTEX7 PRS_CH2 #3 ACMP0_O #0 ETM_TD1 #4 GPIO_EM4WU5
PE12	BUSDY BUSCX LCD_SEG8	EBI_AD04 #0	TIM1_CC2 #1 TIM2_CC1 #3 WTIM0_CDTI2 #0 LETIM0_OUT0 #4	SDIO_CMD #0 ETH_MIIRXD0 #0 US0_RX #3 US0_CLK #0 U1_TX #4 I2C0_SDA #6	CMU_CLK1 #2 CMU_CLKI0 #6 LES_ALTEX6 PRS_CH1 #3 ETM_TD0 #4
PE11	BUSCY BUSDX LCD_SEG7	EBI_AD03 #0 EBI_CS3 #4	TIM1_CC1 #1 TIM4_CC2 #7 WTIM0_CDTI1 #0	SDIO_DAT0 #0 QSPI0_DQ7 #0 ETH_MIIRXDV #0 US0_RX #0	LES_ALTEX5 PRS_CH3 #2 ETM_TCLK #4
PE10	BUSDY BUSCX LCD_SEG6	EBI_AD02 #0 EBI_CS2 #4	TIM1_CC0 #1 TIM4_CC1 #7 WTIM0_CDTI0 #0	SDIO_DAT1 #0 QSPI0_DQ6 #0 ETH_MIIRXER #0 US0_TX #0	PRS_CH2 #2 GPIO_EM4WU9
PE9	BUSCY BUSDX LCD_SEG5	EBI_AD01 #0 EBI_CS1 #4	TIM4_CC0 #7 PCNT2_S1IN #1	SDIO_DAT2 #0 QSPI0_DQ5 #0 US5_RX #0	PRS_CH8 #2
PE8	BUSDY BUSCX LCD_SEG4	EBI_AD00 #0 EBI_CS0 #4	TIM2_CDTI0 #2 TIM4_CC2 #6 PCNT2_S0IN #1	SDIO_DAT3 #0 QSPI0_DQ4 #0 US5_TX #0 I2C2_SDA #0	PRS_CH3 #1
PI9		EBI_A14 #2	TIM1_CC3 #7 TIM4_CC1 #3	US4_CS #3	
PI6		EBI_A11 #2	TIM1_CC0 #7 TIM4_CC1 #2 WTIM3_CC0 #5	US4_TX #3	

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
LES_ALTEX6	0: PE12		LESENSE alternate excite output 6.
LES_ALTEX7	0: PE13		LESENSE alternate excite output 7.
LES_CH0	0: PC0		LESENSE channel 0.
LES_CH1	0: PC1		LESENSE channel 1.
LES_CH2	0: PC2		LESENSE channel 2.
LES_CH3	0: PC3		LESENSE channel 3.
LES_CH4	0: PC4		LESENSE channel 4.
LES_CH5	0: PC5		LESENSE channel 5.
LES_CH6	0: PC6		LESENSE channel 6.
LES_CH7	0: PC7		LESENSE channel 7.
LES_CH8	0: PC8		LESENSE channel 8.
LES_CH9	0: PC9		LESENSE channel 9.
LES_CH10	0: PC10		LESENSE channel 10.

5.22 Analog Port (APORT) Client Maps

The Analog Port (APORT) is an infrastructure used to connect chip pins with on-chip analog clients such as analog comparators, ADCs, DACs, etc. The APORT consists of a set of shared buses, switches, and control logic needed to configurably implement the signal routing. [Figure 5.20 APORT Connection Diagram on page 211](#) shows the APORT routing for this device family (note that available features may vary by part number). A complete description of APORT functionality can be found in the Reference Manual.

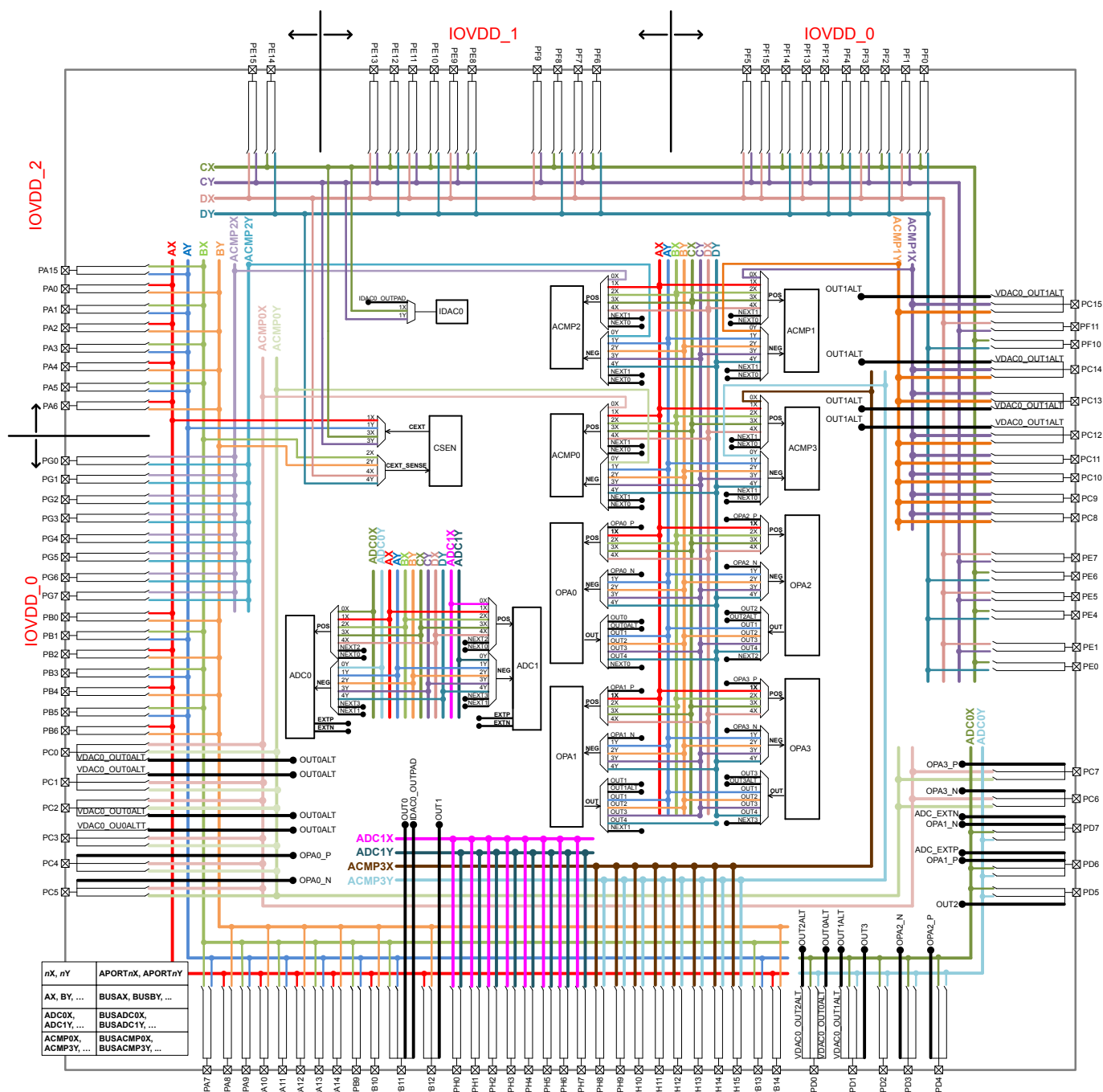


Figure 5.20. APORT Connection Diagram

Client maps for each analog circuit using the APORT are shown in the following tables. The maps are organized by bus, and show the peripheral's port connection, the shared bus, and the connection from specific bus channel numbers to GPIO pins.

In general, enumerations for the pin selection field in an analog peripheral's register can be determined by finding the desired pin connection in the table and then combining the value in the Port column (APORT__), and the channel identifier (CH__). For example, if pin PF7 is available on port APORT2X as CH23, the register field enumeration to connect to PF7 would be APORT2XCH23. The shared bus used by this connection is indicated in the Bus column.

Table 5.31. VDACC0 / OPA Bus and Pin Mapping

OPA0_P							
APORT4X	APORT3X	APORT2X	APORT1X	APORT4Y	APORT3Y	APORT2Y	APORT1Y
BUSDY	BUSCX	BUSBX	BUSAX	BUSDY	BUSCY	BUSBY	BUSAY
PF15		PB15			PF15		PB15
	PF14		PB14	PF14		PB14	
PF13		PB13			PF13		PB13
	PF12		PB12	PF12		PB12	
PF11		PB11			PF11		PB11
	PF10		PB10	PF10		PB10	
PF9		PB9			PF9		PB9
	PF8			PF8			
PF7					PF7		
	PF6		PB6	PF6		PB6	
PF5		PB5			PF5		PB5
	PF4		PB4	PF4		PB4	
PF3		PB3			PF3		PB3
	PF2		PB2	PF2		PB2	
PF1		PB1			PF1		PB1
	PF0		PB0	PF0		PB0	
PE15		PA15			PE15		PA15
	PE14		PA14	PE14		PA14	
PE13		PA13			PE13		PA13
	PE12		PA12	PE12		PA12	
PE11		PA11			PE11		PA11
	PE10		PA10	PE10		PA10	
PE9		PA9			PE9		PA9
	PE8		PA8	PE8		PA8	
PE7		PA7			PE7		PA7
	PE6		PA6	PE6		PA6	
PE5		PA5			PE5		PA5
	PE4		PA4	PE4		PA4	
		PA3					PA3
			PA2			PA2	
PE1		PA1			PE1		PA1
	PE0		PA0	PE0		PA0	

OPA0_N																																	
Port	Bus	CH31	CH30	CH29	CH28	CH27	CH26	CH25	CH24	CH23	CH22	CH21	CH20	CH19	CH18	CH17	CH16	CH15	CH14	CH13	CH12	CH11	CH10	CH9	CH8	CH7	CH6	CH5	CH4	CH3	CH2	CH1	CH0
																														</			

APORT4Y	APORT3Y	APORT2Y	APORT1Y
BUSDY	BUSCY	BUSBY	BUSAY
	PF15		PB15
PF14		PB14	
	PF13		PB13
PF12		PB12	
	PF11		PB11
PF10		PB10	
	PF9		PB9
PF8			
	PF7		
PF6		PB6	
	PF5		PB5
PF4		PB4	
	PF3		PB3
PF2		PB2	
	PF1		PB1
PF0		PB0	
	PE15		PA15
PE14		PA14	
	PE13		PA13
PE12		PA12	
	PE11		PA11
PE10		PA10	
	PE9		PA9
PE8		PA8	
	PE7		PA7
PE6		PA6	
	PE5		PA5
PE4		PA4	
			PA3
		PA2	
	PE1		PA1
PE0		PA0	

11. TQFP64 Package Specifications

11.1 TQFP64 Package Dimensions

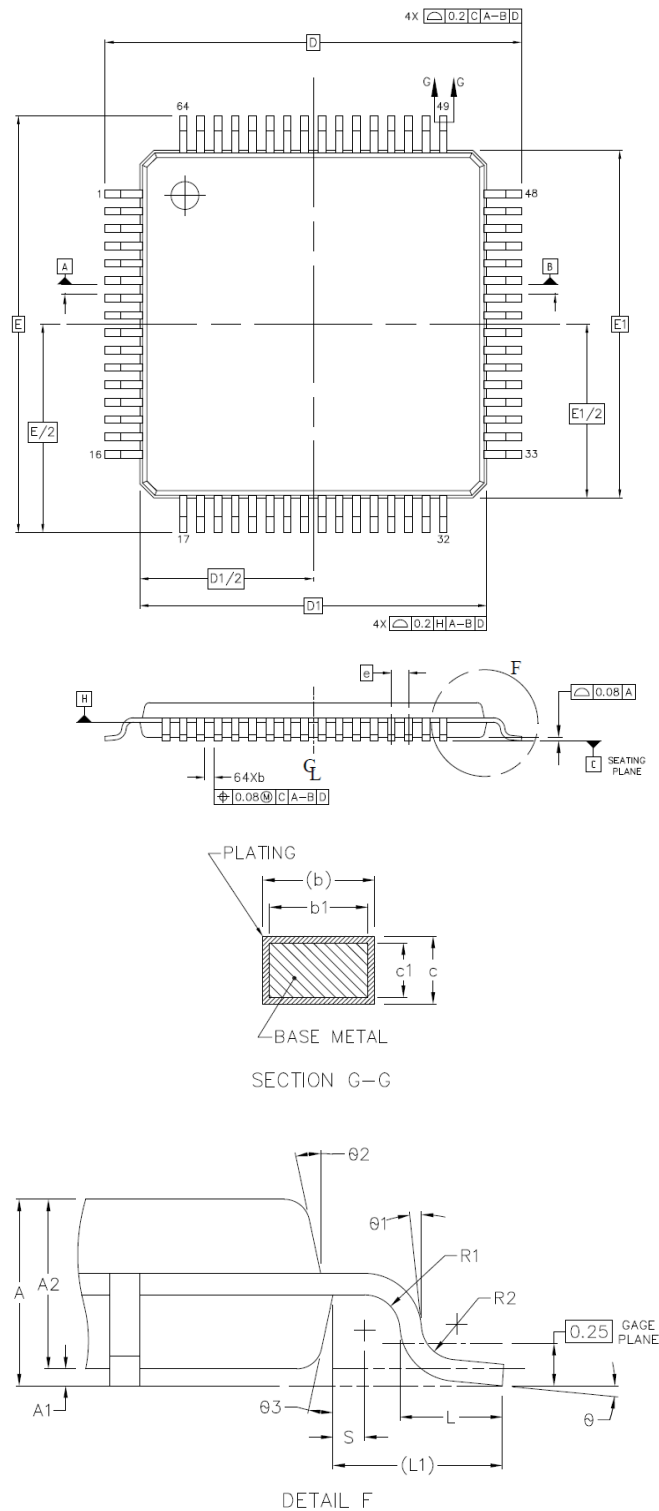


Figure 11.1. TQFP64 Package Drawing